

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>WEI PENG</td> <td>11/15/2012</td> </tr> <tr> <td>WEN-JING LIU</td> <td>11/15/2012</td> </tr> <tr> <td>HSING-YI HU</td> <td>11/15/2012</td> </tr> </tbody> </table>		Name	Execution Date	WEI PENG	11/15/2012	WEN-JING LIU	11/15/2012	HSING-YI HU	11/15/2012
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PROPERTY NUMBERS Total: 1									
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CORRESPONDENCE DATA									
Fax Number:	7147357469								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
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ATTORNEY DOCKET NUMBER:	US43665								

CH \$40.00 13685628

NAME OF SUBMITTER:

D. Austin Bonderer

Total Attachments: 2

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ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

- 1. WEI PENG , residing at Shenzhen, Guangdong, China
- 2. WEN-JING LIU , residing at Shenzhen, Guangdong, China
- 3. HSING-YI HU , residing at Tu-Cheng, New Taipei, Taiwan
- 4. _____ , residing at _____
- 5. _____ , residing at _____
- 6. _____ , residing at _____
- 7. _____ , residing at _____
- 8. _____ , residing at _____

hereby sell(s), assign(s) and transfer(s) unto: **HONG FU JIN PRECISION INDUSTRY (SHENZHEN) CO., LTD.** having a principal place of business at **No. 2, 2nd Donghuan Road, Longhua Town, Bao'an District, Shenzhen City, Guangdong Province 518109, P.R.C.** and **HON HAI PRECISION INDUSTRY CO., LTD.** having a principal place of business at **66, Chung Shan Road, Tu-Cheng Dist., New Taipei City, Taiwan, R.O.C.** hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **MULTI-SECTION TELESCOPING STRUCTURE** for which the undersigned

[] previously executed --- Ser. No. _____ and filing date of _____

[x] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	<u>Wei Peng</u> WEI PENG	<u>2012.11.15</u> Date
2.	<u>Wen-Jing Liu</u> WEN-JING LIU	<u>2012.11.15</u> Date
3.	<u>Hsing-Yi Hu</u> HSING-YI HU	<u>2012.11.15</u> Date
4.	_____	_____ Date
5.	_____	_____ Date
6.	_____	_____ Date
7.	_____	_____ Date
8.	_____	_____ Date
9.	_____	_____ Date